L-C EMI Filter Array with ESD Protection, 4-, 6- and 8-**Channel**

Description

The CM1457 is an inductor-based (L-C) EMI filter array with ESD protection, which integrates four, six, or eight filters in a CSP form factor with 0.40 mm pitch. Each EMI filter channel of the CM1457 is implemented with the component value of 6 pF - 35 nH - 4.7 pF -35 nH - 1.8 pF. The cut-off frequency at -3 dB attenuation is 300 MHz and can be used in applications where the data rates are as high as 160 Mbps, while providing greater than -35 dB attenuation over the 800 MHz to 2.7 GHz frequency range. The parts include ESD diodes on every I/O pin and provide a high level of protection against electrostatic discharge (ESD). The ESD protection diodes connected to the external filter ports are designed and characterized to safely dissipate ESD strikes of ±15 kV, which is beyond the maximum requirement of the IEC61000-4-2 international standard.

This device is particularly well suited for wireless handsets, mobile LCD modules and PDAs because of its small package format and easy-to-use pin assignments. In particular, the CM1457 is ideal for EMI filtering and protecting data and control lines for the LCD display and camera interface in mobile handsets.

The CM1457 incorporates OptiGuard which results in improved reliability at assembly. It is manufactured with a 0.40 mm pitch and 0.25 mm CSP solder ball to provide up to 28% board space savings vs. competing CSP devices with 0.50 mm pitch and 0.30 mm CSP solder ball

Features

- Four, Six or Eight Channels of EMI Filtering
- ±15 kV ESD Protection (IEC 61000-4-2, Contact Discharge) at **External Pins**
- Greater than -40 dB of Attenuation at 1 GHz MIL-STD-883 International ESD Standard
- Chip Scale Package (CSP) with 0.40 mm Pitch and 0.25 mm CSP Solder Ball which Features Extremely Low Parasitic Inductance for Optimum Filter and ESD Performance
- OptiGuard Coating for Improved Reliability at Assembly
- These Devices are Pb-Free and are RoHS Compliant

Applications

- LCD and Camera Data Lines in Mobile Handsets
- I/O Port Protection for Mobile Handsets, Notebook Computers, PDAs, etc.
- EMI Filtering for Data Ports in Cell Phones, PDAs or Notebook Computers
- Wireless Handsets
- Handheld PCs/PDAs
- LCD and Camera Modules



ON Semiconductor®

http://onsemi.com





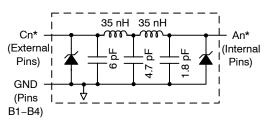


WLCSP10 **CP SUFFIX** CASE 567BJ

WLCSP15 **CP SUFFIX** CASE 567BR

WLCSP20 **CP SUFFIX** CASE 567BV

BLOCK DIAGRAM



MARKING DIAGRAM

N57 w

N57 yww

N57 yyww

CM1457-04 10-Bump CSP 15-Bump CSP

CM1457-06

CM1457-08 20-Bump CSP

N57 = CM1457-04CP N57 = CM1457-06CP = CM1457-08CP w/yww/yyww = date code

ORDERING INFORMATION

| Device | Package | Shipping [†] |
|-------------|---------------------|-----------------------|
| CM1457-04CP | CSP-10 (Pb-Free) | 3500/Tape & Reel |
| CM1457-06CP | CSP-15 (Pb-Free) | 3500/Tape & Reel |
| CM1457-08CP | CSP-20 (Pb-Free) | 3500/Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

CM1457

PACKAGE / PINOUT DIAGRAMS

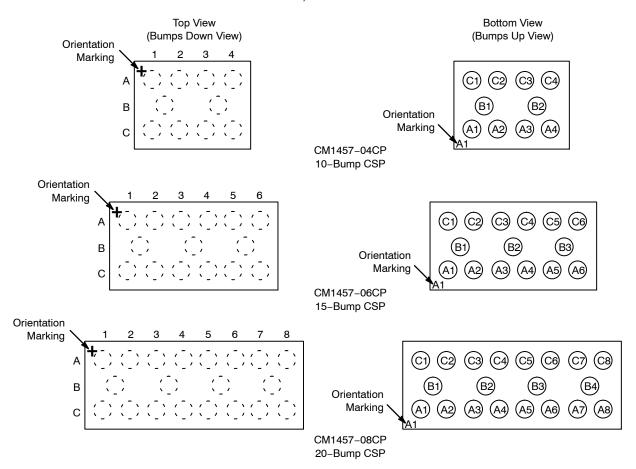


Table 1. PIN DESCRIPTIONS

| | Pin Number | | | | Pin Number | | |
|--------|------------|-------|----------------------|-----|------------|-----|----------------------|
| -04 | -06 | -08 | Pin Description | -04 | -06 | -08 | Pin Description |
| A1 | A1 | A1 | Filter #1 (Internal) | C1 | C1 | C1 | Filter #1 (External) |
| A2 | A2 | A2 | Filter #2 (Internal) | C2 | C2 | C2 | Filter #2 (External) |
| A3 | A3 | A3 | Filter #3 (Internal) | C3 | СЗ | C3 | Filter #3 (External) |
| A4 | A4 | A4 | Filter #4 (Internal) | C4 | C4 | C4 | Filter #4 (External) |
| - | A5 | A5 | Filter #5 (Internal) | - | C5 | C5 | Filter #5 (External) |
| - | A6 | A6 | Filter #6 (Internal) | - | C6 | C6 | Filter #6 (External) |
| - | = | A7 | Filter #7 (Internal) | - | - | C7 | Filter #7 (External) |
| - | _ | A8 | Filter #8 (Internal) | - | - | C8 | Filter #8 (External) |
| B1, B2 | B1-B3 | B1-B4 | GND | | | | |

CM1457

SPECIFICATIONS

Table 2. ABSOLUTE MAXIMUM RATINGS

| Parameter | Rating | Units |
|---------------------------|-------------|-------|
| Storage Temperature Range | -65 to +150 | °C |
| DC current per Inductor | 15 | mA |
| DC Package Power Rating | 0.5 | W |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Table 3. STANDARD OPERATING CONDITIONS

| Parameter | Rating | Units |
|-----------------------------|------------|-------|
| Operating Temperature Range | -40 to +85 | °C |

Table 4. ELECTRICAL OPERATING CHARACTERISTICS (Note 1)

| Symbol | Parameter | Conditions | Min | Тур | Max | Units |
|-----------------------|---|---|-------------|-------------|-------------|-------|
| L _{TOT} | Total Channel Inductance | | | 70 | | nΗ |
| R _{TOT} | Total Channel DC Resistance | | | 45 | | Ω |
| C _{TOT_0V} | Total Channel Capacitance, 0 V bias | 0 V dc; 1 MHz, 30 mV rms | | 20 | 24 | pF |
| C _{TOT_2.5V} | Total Channel Capacitance, 2.5 V bias | 2.5 V dc; 1 MHz, 30 mV rms | | 12.5 | | pF |
| V _{ST} | Stand-off Voltage | Ι = 10 μΑ | 5.5 | | | V |
| I _{LEAK} | Diode Leakage Current | V _{IN} = +3.3 V | | 0.1 | 0.5 | μΑ |
| V _{SIG} | Signal Clamp Voltage Positive Clamp Negative Clamp | I _{LOAD} = 10 mA I _{LOAD} = -10 mA | 5.6 -1.5 | 6.8 -0.8 | 9.0 -0.4 | V |
| V _{ESD} | In-system ESD Withstand Voltage a) Contact Discharge per IEC 61000-4-2 standard, Level 4 (External Pins) b) Contact Discharge per IEC 61000-4-2 standard, Level 4 (Internal Pins) | (Notes 2 and 3) | ±15 | | | kV |
| f _C | Cut-off Frequency Z_{SOURCE} = 50 Ω , Z_{LOAD} = 50 Ω | | | 300 | | MHz |

APPLICATION INFORMATION

Refer to Application Note "The Chip Scale Package", for a detailed description of Chip Scale Packages offered by ON Semiconductor.

T_A = 25°C unless otherwise specified.
 ESD applied to input and output pins with respect to GND, one at a time.

^{3.} Unused pins are left open.

CM1457

PERFORMANCE INFORMATION

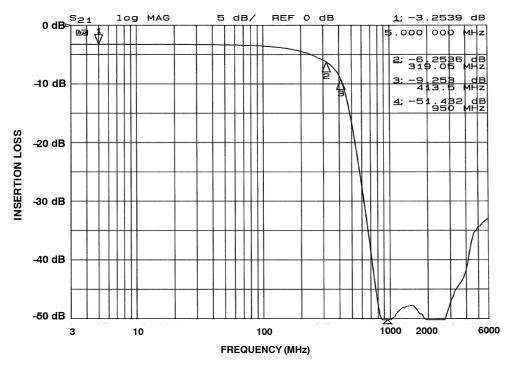


Figure 1. Insertion Loss vs. Frequency (0 V Bias)

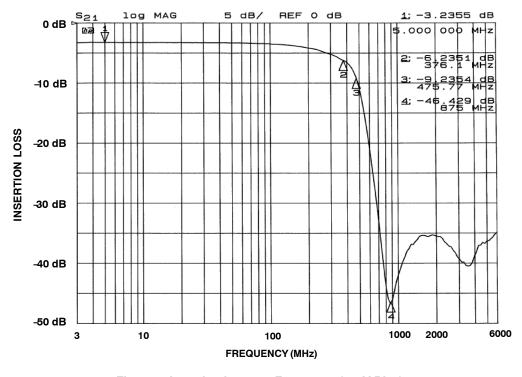


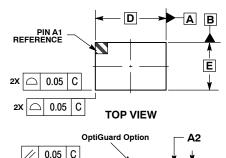
Figure 2. Insertion Loss vs. Frequency (2.5 V Bias)

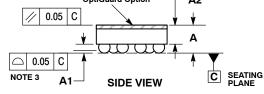


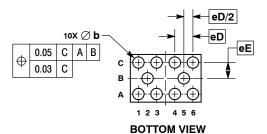


WLCSP10, 1.67x1.05 CASE 567BJ-01 ISSUE O

DATE 26 JUL 2010



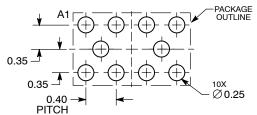




- NOTES: 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- 2. CONTROLLING DIMENSION: MILLIMETERS.
 3. COPLANARITY APPLIES TO SPHERICAL CROWNS OF SOLDER BALLS.

| | MILLIMETERS | | | |
|-----|-------------|------|--|--|
| DIM | MIN | MAX | | |
| Α | 0.54 | 0.69 | | |
| A1 | 0.17 | 0.24 | | |
| A2 | 0.42 REF | | | |
| b | 0.24 0.29 | | | |
| D | 1.67 BSC | | | |
| E | 1.05 BSC | | | |
| eD | 0.400 BSC | | | |
| еE | 0.347 | BSC | | |

RECOMMENDED SOLDERING FOOTPRINT*



DIMENSIONS: MILLIMETERS

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

| DOCUMENT NUMBER: | 98AON49818E | Electronic versions are uncontrolled except when accessed directly from the Document Repositor Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red. | |
|------------------|--------------------|---|-------------|
| DESCRIPTION: | WLCSP10, 1.67X1.05 | | PAGE 1 OF 1 |

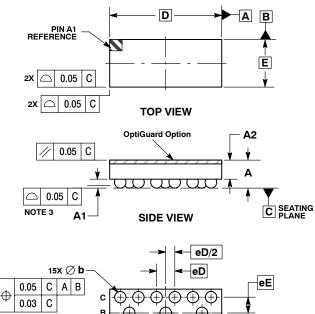
ON Semiconductor and (III) are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.





WLCSP15, 2.47x1.05 CASE 567BR-01 **ISSUE O**

DATE 26 JUL 2010

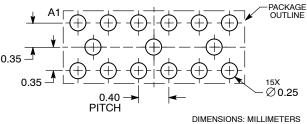


BOTTOM VIEW

- NOTES: 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- CONTROLLING DIMENSION: MILLIMETERS.
 COPLANARITY APPLIES TO SPHERICAL CROWNS OF SOLDER BALLS.

| | MILLIMETERS | | | |
|-----|-------------|----------|--|--|
| DIM | MIN | MAX | | |
| Α | 0.54 | 0.69 | | |
| A1 | 0.17 | 0.24 | | |
| A2 | 0.42 | 0.42 REF | | |
| b | 0.24 0.29 | | | |
| D | 2.47 BSC | | | |
| Е | 1.05 BSC | | | |
| eD | 0.400 BSC | | | |
| еE | 0.347 | BSC | | |

RECOMMENDED SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

| DOCUMENT NUMBER: | 98AON49825E | Electronic versions are uncontrolled except when accessed directly from the Document Repository Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red. | |
|------------------|--------------------|--|-------------|
| DESCRIPTION: | WLCSP15, 2.47X1.05 | | PAGE 1 OF 1 |

ON Semiconductor and (III) are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.



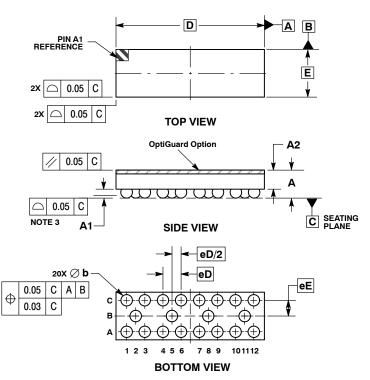


WLCSP20, 3.27x1.05 CASE 567BV-01 ISSUE O

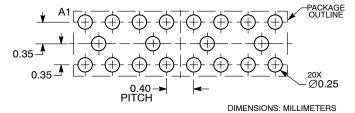
DATE 26 JUL 2010

- NOTES: 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- 2. CONTROLLING DIMENSION: MILLIMETERS.
 3. COPLANARITY APPLIES TO SPHERICAL CROWNS OF SOLDER BALLS.

| CHOWING OF SOLDER | | | | |
|-------------------|-------------|------|--|--|
| | MILLIMETERS | | | |
| DIM | MIN | MAX | | |
| Α | 0.54 | 0.69 | | |
| A1 | 0.17 0.24 | | | |
| A2 | 0.42 REF | | | |
| b | 0.24 | 0.29 | | |
| D | 3.27 BSC | | | |
| E | 1.05 BSC | | | |
| eD | 0.400 BSC | | | |
| еE | 0.347 | BSC | | |



RECOMMENDED SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

| DOCUMENT NUMBER: | 98AON49829E | Electronic versions are uncontrolled except when accessed directly from the Document Repositor Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red. | |
|------------------|--------------------|--|-------------|
| DESCRIPTION: | WLCSP20, 3.27X1.05 | | PAGE 1 OF 1 |

ON Semiconductor and (III) are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. Onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any EDA class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer pu

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:
Email Requests to: orderlit@onsemi.com

onsemi Website: www.onsemi.com

TECHNICAL SUPPORT North American Technical Support: Voice Mail: 1 800-282-9855 Toll Free USA/Canada Phone: 011 421 33 790 2910

Europe, Middle East and Africa Technical Support:

Phone: 00421 33 790 2910

For additional information, please contact your local Sales Representative

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for EMI Filter Circuits category:

Click to view products by ON Semiconductor manufacturer:

Other Similar products are found below:

761280-1 SBSGC0500224MXB SBSPP0250104MXT SBSPP0250154MXT SBSPP0500473MXT SBSPP1000102MXT

SBSPP1000153MXB SBSPP1000220MCT SBSPP1000332MXT SBSPP1000470MCT SBSPP1000471MCT SBSPP1000472MXT

SNZF220DFT1G CM1442-06CP EMI8041MUTAG SBSPP0500473MXB SBSPP1000101MCT SBSPP1000103MXT SBSPP1000220MCB

SBSPP1000221MCT EMIF06-USD05F3 EMIF03-SIM03F3 EMI7112FCTAG EMI7403FCTBG EMI2180MTTBG CM1442-08CP

CSPEMI204FCTAG SBSPP1000152MXT SBSGC5000473MXT SBSMC0500474MXT EMI8043MUTAG MEA2010PE360T001

NFA18SL307V1A45L 1-6609037-5 CM1690-06DE EMIF05-SK01F3 EMIF02-USB03F2 BNX022-01L BNX024H01L BNX025H01L

BNX026H01L NFA21SL806X1A48L NFL18SP157X1A3D NFL21SP106X1C3D NFL21SP207X1C3D NFL21SP307X1C3D

NFL21SP506X1C3D NFL21SP706X1C3D NFW31SP207X1E4L BNX022-01B